

- ◆ **Variable Duty Ratio: 55%/75%**
- ◆ **CMOS Low Power Consumption**
- ◆ **Operating Voltage: 0.9V~10.0V**
- ◆ **Output Voltage Range: 2.0V~7.0V**
- ◆ **Output Voltage Accuracy: ±2.5%**

■ Applications

- Cellular phones, pagers
- Palmtops
- Cameras, video recorders
- Portable equipment

■ General Description

The XC6383 Series is a group of PFM controlled step-up DC/DC converters. Unlike conventional PFM's, the XC6383 automatically switches duty ratio (55%/75%) when it senses changes in load and can support both large and small currents.

The XC6383 series employs CMOS process and laser trimming technologies so as to attain low power and high accuracy. Max. oscillator frequency is trimmed to 100kHz (accuracy: ±15%).

Every built-in switching transistor type enables a step-up circuit to be configured using only three external components ; a coil, a diode, and a capacitor. External transistor versions are available to accommodate high output current applications.

Both built-in and external transistor types include 5-pin and 3-pin packages, which are provided with either a CE (chip enable) function that reduces power comsumption during shut-down mode, or a V_{DD} pin function (separated power and voltage detect pins).

SOT-23, SOT-25, and SOT-89-5 super mini-mold packages.

■ Features

Operating (start-up) voltage range: 0.9V~10V

Output voltage range: 2.0V~7.0V in 0.1V increments

Highly accurate: Set-up voltage ±2.5%

Maximum oscillator frequency: 100kHz (±15%)

Variable Duty Ratio: 55%/75% (±5%)

Both switching transistor built-in and external types are available

Five-lead packaged units offer either Chip Enable or independent V_{OUT} pin option.

Small package: SOT-23, 25 mini-mold (3-pin, 5-pin)

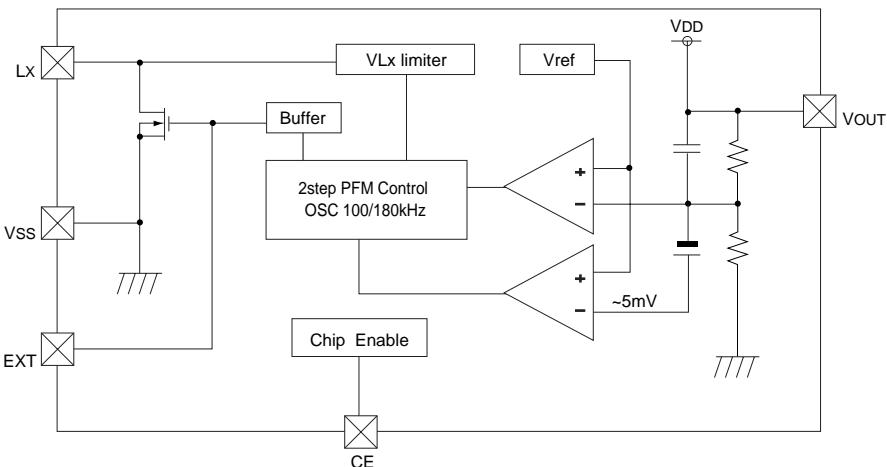
SOT-89, 89-5 mini-power mold (3-pin, 5-pin)

■ Selection Guide

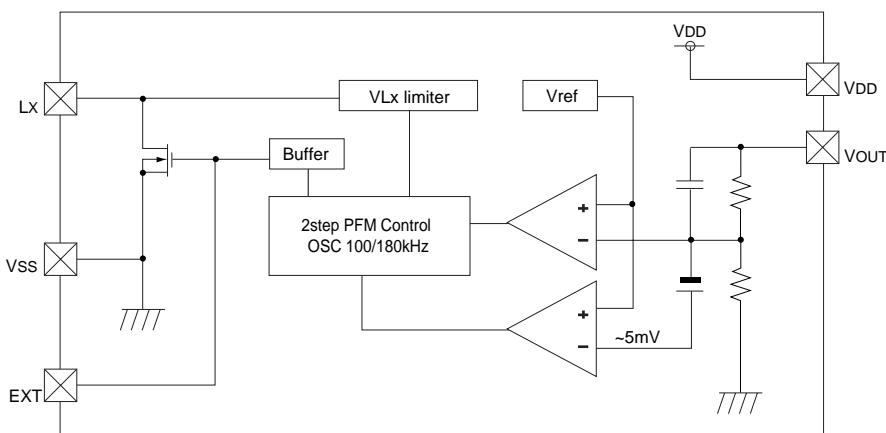
PART TYPE	DUTY RATIO	PACKAGE	SWITCHING RELATED	ADDITIONAL FUNCTION	FEATURES
XC6383A	Switchable	SOT-23, SOT-89-3	Built-in Transistor "Lx" lead		<ul style="list-style-type: none"> • Automatic duty ratio switch. • Low ripple and highly efficient from low current to high current.
XC6383B	Switchable	SOT-23, SOT-89-3	External Transistor "EXT" lead		<ul style="list-style-type: none"> • Automatic duty ratio switch. • Adding an external transistor can improve the output capability by up to several hundred mA.
XC6383C	Switchable	SOT-25, SOT-89-5	Built-in Transistor "Lx" lead	Chip Enable(CE)	<ul style="list-style-type: none"> • Stand-by (CE) function added version to the XC6383A. • Stand-by current: 0.5µA max.
XC6383D	Switchable	SOT-25, SOT-89-5	External Transistor "EXT" lead	Chip Enable(CE)	<ul style="list-style-type: none"> • Stand-by (CE) function added version to the XC6383B. • Stand-by current: 0.5µA max.
XC6383E	Switchable	SOT-25, SOT-89-5	Built-in Transistor "Lx" lead	Separated "V _{DD} " and "V _{OUT} " leads	Independent power supply and set-up voltage sensing leads allow designing of PFM controllers.
XC6383F	Switchable	SOT-25, SOT-89-5	External Transistor "EXT" lead	Separated "V _{DD} " and "V _{OUT} " leads	Independent power supply and set-up voltage sensing leads allow designing of PFM controllers.

■ Block Diagram

XC6383A~XC6383D (V_{DD} is internally connected to the V_{OUT} pin.)



XC6383E and XC6383F

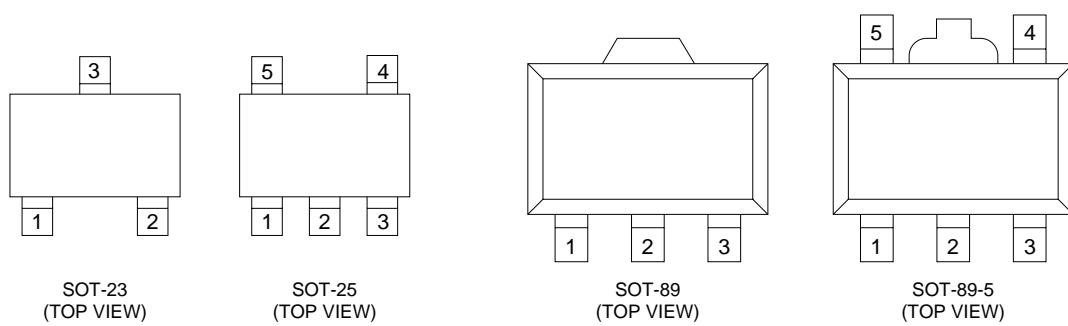


■ Absolute Maximum Ratings

T_a=25°C

PARAMETER		SYMBOL	RATINGS	UNITS
V _{OUT} Input Voltage		V _{OUT}	12	V
Lx pin Voltage		VLx	12	V
Lx pin Current		I _{Lx}	400	mA
EXT pin Voltage		V _{EXT}	V _{SS} -0.3 ~ V _{OUT} +0.3	V
EXT pin Current		I _{EXT}	±50	mA
CE Input Voltage		V _{CE}	12	V
V _{DD} Input Voltage		V _{DD}	12	V
Continuous Total Power Dissipation	SOT-23	P _d	150	mW
	SOT-89		500	
Operating Ambient Temperature		T _{opr}	-30 ~ +80	°C
Storage Temperature		T _{stg}	-40 ~ +125	°C

■ Pin Configuration



■ Pin Assignment

(XC6383A, XC6383B)

PIN NUMBER				PIN NAME	FUNCTION
XC6383A		XC6383B			
SOT-23	SOT-89-3	SOT-23	SOT-89-3		
1	1	1	1	Vss	Ground
3	2	3	2	Vout	Output voltage monitor, IC internal power supply
2	3	--	--	Lx	Switch
--	--	2	3	EXT	External switch transistor drive

(XC6383C, XC6383D)

PIN NUMBER				PIN NAME	FUNCTION
XC6383C		XC6383D			
SOT-25	SOT-89-5	SOT-25	SOT-89-5		
4	5	4	5	Vss	Ground
2	2	2	2	Vout	Output voltage monitor, IC internal power supply
5	4	--	--	Lx	Switch
--	--	5	4	EXT	External switch transistor drive
1	3	1	3	CE	Chip enable
3	1	3	1	NC	No Connection

(XC6383E, XC6383F)

PIN NUMBER				PIN NAME	FUNCTION
XC6383E		XC6383F			
SOT-25	SOT-89-5	SOT-25	SOT-89-5		
4	5	4	5	Vss	Ground
2	2	2	2	Vdd	IC internal power supply
5	4	--	--	Lx	Switch
--	--	5	4	EXT	External switch transistor drive
1	3	1	3	Vout	Output voltage monitor
3	1	3	1	NC	No Connection

■ Electrical Characteristics

XC6383A201MR V_{OUT}=2.0V

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Voltage	V _{OUT}	L, SD, C _L etc. connected	1.950	2.000	2.050	V
Maximum Input Voltage	V _{IN}		10			V
Oscillation Start-up Voltage	V _{ST}	I _{OUT} =1mA		0.80	0.90	V
Oscillation Hold Voltage	V _{HLD}	I _{OUT} =1mA	0.70			V
No-Load Input Current	I _{IN}	I _{OUT} =0mA(Note1)		4.3	8.6	μA
Supply Current 1(Note2)	I _{DD1}	V _{IN} =V _{OUT} × 0.95		13.6	27.3	μA
Supply Current 2	I _{DD2}	V _{IN} =V _{OUT} +0.5V		1.9	3.9	μA
Lx Switch-On Resistance	R _{SWON}	Same as I _{DD1} . VLx=0.4V.		9.1	13.7	Ω
Lx Leakage Current	I _{LXL}	No external components. V _{OUT} =VLx=0.4V.			1.0	μA
Duty Ratio 1	DTY1	Same as I _{DD1} . Measuring of Lx waveform.	70	75	80	%
Duty Ratio 2	DTY2	I _{OUT} =1mA. Measuring of Lx on-time	50	55	60	%
Maximum Oscillation Frequency1	MAX Fosc1	Same as I _{DD1} . 75% duty.	85	100	115	kHz
Maximum Oscillation Frequency2	MAX Fosc2	Same as I _{DD1} . 55% duty.	153	180	207	kHz
Lx Limit Voltage	VLxLMT	Same as I _{DD1} . Fosc>MAXFosc1 × 2	0.7		1.1	V
Efficiency	EFFI	L, SD, C _L etc. connected		70		%

Measuring conditions: Unless otherwise specified, V_{IN}=V_{OUT} × 0.6, I_{OUT}=10mA. See Typical Application Circuits, Fig.1.Note: 1. The Schottky diode (SD) must be type MA735, with reverse current (I_R) < 1.0μA at reverse voltage (V_R)=10.0V

2. "Supply Current 1" is the supply current while the oscillator is continuously oscillating. In actual operation the oscillator periodically operates which results in less average power consumption. The current actually provided by an external V_{IN} source is represented by "No-Load Input Current (I_{IN})".

XC6383A301MR V_{OUT}=3.0V

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Voltage	V _{OUT}	L, SD, C _L etc. connected	2.925	3.000	3.075	V
Maximum Input Voltage	V _{IN}		10			V
Oscillation Start-up Voltage	V _{ST}	I _{OUT} =1mA		0.80	0.90	V
Oscillation Hold Voltage	V _{HLD}	I _{OUT} =1mA	0.70			V
No-Load Input Current	I _{IN}	I _{OUT} =0mA(Note1)		4.6	9.3	μA
Supply Current 1(Note2)	I _{DD1}	V _{IN} =V _{OUT} × 0.95		19.7	39.4	μA
Supply Current 2	I _{DD2}	V _{IN} =V _{OUT} +0.5		2.1	4.2	μA
Lx Switch-On Resistance	R _{SWON}	Same as I _{DD1} . VLx=0.4V.		5.2	7.9	Ω
Lx Leakage Current	I _{LXL}	No external components. V _{OUT} =VLx=10V.			1.0	μA
Duty Ratio 1	DTY1	Same as I _{DD1} . Measuring of Lxg waveform.	70	75	80	%
Duty Ratio 2	DTY2	I _{OUT} =1mA. Measuring of Lx on-time	50	55	60	%
Maximum Oscillation Frequency1	MAX Fosc1	Same as I _{DD1} . 75% duty	85	100	115	kHz
Maximum Oscillation Frequency2	MAX Fosc2	Same as I _{DD1} . 55% duty	153	180	207	kHz
Lx Limit Voltage	VLxLMT	Same as I _{DD1} . Fosc>MAXFosc1 × 2	0.7		1.1	V
Efficiency	EFFI	L, SD, C _L etc. connected		80		%

Measuring conditions: Unless otherwise specified, V_{IN}=V_{OUT} × 0.6, I_{OUT}=30mA. See Typical Application Circuits, Fig.1.Note: 1. The Schottky diode (SD) must be type MA735, with reverse current (I_R) < 1.0μA at reverse voltage (V_R)=10.0V

2. "Supply Current 1" is the supply current while the oscillator is continuously oscillating. In actual operation the oscillator periodically operates which results in less average power consumption. The current actually provided by an external V_{IN} source is represented by "No-Load Input Current (I_{IN})".

■ Electrical Characteristics

XC6383A501MR V_{OUT}=5.0V

T_a=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Voltage	V _{OUT}	L, SD, C _L etc. connected	4.875	5.000	5.125	V
Maximum Input Voltage	V _{IN}		10			V
Oscillation Start-up Voltage	V _{ST}	I _{OUT} =1mA		0.80	0.90	V
Oscillation Hold Voltage	V _{HLD}	I _{OUT} =1mA	0.70			V
No-Load Input Current	I _{IN}	I _{OUT} =0mA (Note1)		5.3	10.6	μA
Supply Current 1 (Note2)	I _{DD1}	V _{IN} =V _{OUT} × 0.95		31.7	63.4	μA
Supply Current 2	I _{DD2}	V _{IN} =V _{OUT} +0.5V		2.4	4.8	μA
L _x Switch-On Resistance	R _{SWON}	Same as I _{DD1} . V _{Lx} =0.4V.		2.8	4.3	Ω
L _x Leakage Current	I _{LXL}	No external components. V _{OUT} =V _{Lx} =10V.			1.0	μA
Duty Ratio 1	DTY1	Same as I _{DD1} . Measuring of L _x waveform.	70	75	80	%
Duty Ratio 2	DTY2	I _{OUT} =1mA. Measuring of L _x on-time	50	55	60	%
Maximum Oscillation Frequency1	MAX Fosc1	Same as I _{DD1} . 75% duty.	85	100	115	kHz
Maximum Oscillation Frequency2	MAX Fosc2	Same as I _{DD1} . 55% duty.	153	180	207	kHz
L _x Limit Voltage	V _{LxLMT}	Same as I _{DD1} . Fosc>MAXFosc1 × 2	0.7		1.1	V
Efficiency	EFFI	L, SD, C _L etc. connected		85		%

Measuring conditions: Unless otherwise specified, V_{IN}=V_{OUT} × 0.6, I_{OUT}=50mA. See Typical Application Circuits, Fig.1.

- Note: 1. The Schottky diode (SD) must be type MA735, with reverse current (IR) < 1.0μA at reverse voltage (VR)=10.0V
 2. "Supply Current 1" is the supply current while the oscillator is continuously oscillating. In actual operation the oscillator periodically operates which results in less average power consumption. The current actually provided by an external V_{IN} source is represented by "No-Load Input Current (I_{IN})".

XC6383B201MR V_{OUT}=2.0V

T_a=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Voltage	V _{OUT}	L, SD, C _L , Tr., etc. connected	1.950	2.000	2.050	V
Maximum Input Voltage	V _{IN}		10			V
Oscillation Start-up Voltage	V _{ST}	I _{OUT} =1mA		0.80	0.90	V
Oscillation Hold Voltage	V _{HLD}	I _{OUT} =1mA	0.70			V
Supply Current 1 (Note 1)	I _{DD1}	V _{IN} =V _{OUT} × 0.95		13.6	27.3	μA
Supply Current 2	I _{DD2}	V _{IN} =V _{OUT} +0.5V		1.9	3.9	μA
EXT "High" On Resistance	R _{EXTH}	Same as I _{DD1} . V _{EXT} =V _{OUT} -0.4V.		140	210	Ω
EXT "Low" On Resistance	R _{EXTL}	Same as I _{DD1} . V _{EXT} =0.4V.		140	210	Ω
Duty Ratio 1	DTY1	Same as I _{DD1} . Measuring of EXT waveform.	70	75	80	%
Duty Ratio 2	DTY2	I _{OUT} =1mA. Measuring of EXT on-time.	50	55	60	%
Maximum Oscillation Frequency1	MAX Fosc1	Same as I _{DD1} . 75% duty	85	100	115	kHz
Maximum Oscillation Frequency2	MAX Fosc2	Same as I _{DD1} . 55% duty	153	180	207	kHz
Efficiency	EFFI	L, SD, C _L , Tr., etc. connected		70		%

Measuring conditions: Unless otherwise specified, V_{IN}=V_{OUT} × 0.6, I_{OUT}=10mA. See Typical Application Circuits, Fig.2.

- Note: 1. "Supply Current 1" is the supply current while the oscillator is continuously oscillating. In actual operation the oscillator periodically operates which results in less average power consumption.

■ Electrical Characteristics

XC6383B301MR V_{OUT}=3.0V

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Voltage	V _{OUT}	L, SD, C _L , Tr., etc. connected	2.925	3.000	3.075	V
Maximum Input Voltage	V _{IN}		10			V
Oscillation Start-up Voltage	V _{ST}	I _{OUT} =1mA		0.80	0.90	V
Oscillation Hold Voltage	V _{HLD}	I _{OUT} =1mA	0.70			V
Supply Current 1(Note 1)	I _{DD1}	V _{IN} =V _{OUT} × 0.95		19.7	39.4	µA
Supply Current 2	I _{DD2}	V _{IN} =V _{OUT} +0.5V		2.1	4.2	µA
EXT "High" On Resistance	R _{EXTH}	Same as I _{DD1} . V _{EXT} =V _{OUT} -0.4V.		76	114	Ω
EXT "Low" On Resistance	R _{EXTL}	Same as I _{DD1} . V _{EXT} =0.4V.		76	114	Ω
Duty Ratio 1	DTY1	Same as I _{DD1} . Measuring of EXT waveform.	70	75	80	%
Duty Ratio 2	DTY2	I _{OUT} =1mA. Measuring of EXT on-time.	50	55	60	%
Maximum Oscillation Frequency1	MAX Fosc1	Same as I _{DD1} . 75% duty.	85	100	115	kHz
Maximum Oscillation Frequency2	MAX Fosc2	Same as I _{DD1} . 55% duty.	153	180	207	kHz
Efficiency	EFFI	L, SD, C _L , Tr., etc. connected		80		%

Measuring conditions: Unless otherwise specified, V_{IN}=V_{OUT} × 0.6, I_{OUT}=30mA. See Typical Application Circuits, Fig.2.

Note: 1. "Supply Current 1" is the supply current while the oscillator is continuously oscillating. In actual operation the oscillator periodically operates which results in less average power consumption.

XC6383B501MR V_{OUT}=5.0V

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Voltage	V _{OUT}	L, SD, C _L , Tr., etc. connected	4.875	5.000	5.125	V
Maximum Input Voltage	V _{IN}		10			V
Oscillation Start-up Voltage	V _{ST}	I _{OUT} =1mA		0.80	0.90	V
Oscillation Hold Voltage	V _{HLD}	I _{OUT} =1mA	0.70			V
Supply Current 1(Note 1)	I _{DD1}	V _{IN} =V _{OUT} × 0.95		31.7	63.4	µA
Supply Current 2	I _{DD2}	V _{IN} =V _{OUT} +0.5V		2.4	4.8	µA
EXT "High" On Resistance	R _{EXTH}	Same as I _{DD1} . V _{EXT} =V _{OUT} -0.4V.		50	75	Ω
EXT "Low" On Resistance	R _{EXTL}	Same as I _{DD1} . V _{EXT} =0.4V.		50	75	Ω
Duty Ratio 1	DTY1	Same as I _{DD1} . Measuring of EXT waveform.	70	75	80	%
Duty Ratio 2	DTY2	I _{OUT} =1mA. Measuring of EXT on-time.	55	55	60	%
Maximum Oscillation Frequency1	MAX Fosc1	Same as I _{DD1} . 75% duty.	85	100	115	kHz
Maximum Oscillation Frequency2	MAX Fosc2	Same as I _{DD1} . 55% duty.	153	180	207	kHz
Efficiency	EFFI	L, SD, C _L , Tr., etc. connected		85		%

Measuring conditions: Unless otherwise specified, V_{IN}=V_{OUT} × 0.6, I_{OUT}=50mA. See Typical Application Circuits, Fig.2.

Note: 1. "Supply Current 1" is the supply current while the oscillator is continuously oscillating. In actual operation the oscillator periodically operates which results in less average power consumption.

■ Electrical Characteristics

XC6383C201MR V_{OUT}=2.0V

T_a=25°C

Output Voltage	V _{OUT}	L, SD, C _L etc. connected	1.950	2.000	2.050	V
Maximum Input Voltage	V _{IN}		10			V
Oscillation Start-up Voltage	V _{ST}	I _{OUT} =1mA		0.80	0.90	V
Oscillation Hold Voltage	V _{HLD}	I _{OUT} =1mA	0.70			V
No-Load Input Current	I _{IN}	I _{OUT} =0mA(Note1)		4.3	8.6	μA
Supply Current 1(Note2)	I _{DD1}	V _{IN} =V _{OUT} × 0.95		13.6	27.3	μA
Supply Current 2	I _{DD2}	V _{IN} =V _{OUT} +0.5V		1.9	3.9	μA
Lx Switch-On Resistance	R _{SWON}	Same as I _{DD1} . V _{Lx} =0.4V.		9.1	13.7	Ω
Lx Leakage Current	I _{LxL}	No external components. V _{OUT} =V _{Lx} =10V.			1.0	μA
Duty Ratio 1	DTY1	Same as I _{DD1} . Measuring of Lx waveform.	70	75	80	%
Duty Ratio 2	DTY2	I _{OUT} =1mA. Measuring of Lx on-time.	50	55	60	%
Maximum Oscillation Frequency1	MAX Fosc1	Same as I _{DD1} . 75% duty.	85	100	115	kHz
Maximum Oscillation Frequency2	MAX Fosc2	Same as I _{DD1} . 55% duty.	153	180	207	kHz
Stand-by Current	I _{STB}	Same as I _{DD1} .			0.5	μA
CE "High" Voltage	V _{CEH}	Same as I _{DD1} . Existence of Lx Oscillation.	0.75			V
CE "Low" Voltage	V _{CEL}	Same as I _{DD1} . Disappearance of Lx Oscillation.			0.20	V
CE "High" Current	I _{C EH}	Same as I _{DD1} . V _{CE} =V _{OUT} × 0.95			0.25	μA
CE "Low" Current	I _{C EL}	Same as I _{DD1} . V _{CE} =0V.			-0.25	μA
Lx Limit Voltage	V _{LxLMT}	Same as I _{DD1} . Fosc>MAXFosc1 × 2	0.7		1.1	V
Efficiency	EFFI	L, SD, C _L etc. connected		70		%

Measuring conditions: Unless otherwise specified, connect CE to V_{OUT}, V_{IN}=V_{OUT} × 0.6, I_{OUT}=10mA. See Typical Application Circuits, Fig.3.

Note: 1. The Schottky diode (SD) must be type MA735, with reverse current (I_R) < 1.0μA at reverse voltage (V_R)=10.0V

2. "Supply Current 1" is the supply current while the oscillator is continuously oscillating. In actual operation the oscillator periodically operates which results in less average power consumption. The current actually provided by an external V_{IN} source is represented by "No-Load Input Current (I_{IN})".

■ Electrical Characteristics

XC6383C301MR V_{OUT}=3.0V

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Voltage	V _{OUT}	L, SD, C _L etc. connected	2.925	3.000	3.075	V
Maximum Input Voltage	V _{IN}		10			V
Oscillation Start-up Voltage	V _{ST}	I _{OUT} =1mA		0.80	0.90	V
Oscillation Hold Voltage	V _{HLD}	I _{OUT} =1mA	0.70			V
No-Load Input Current	I _{IN}	I _{OUT} =0mA(Note1)		4.6	9.3	μA
Supply Current 1(Note2)	I _{DD1}	V _{IN} =V _{OUT} × 0.95		19.7	39.4	μA
Supply Current 2	I _{DD2}	V _{IN} =V _{OUT} +0.5V		2.1	4.2	μA
Lx Switch-On Resistance	R _{SWON}	Same as I _{DD1} . VLx=0.4V.		5.2	7.9	Ω
Lx Leakage Current	I _{LxL}	No external components. V _{OUT} =VLx=10V.			1.0	μA
Duty Ratio 1	DTY1	Same as I _{DD1} . Measuring of Lx waveform.	70	75	80	%
Duty Ratio 2	DTY2	I _{OUT} =1mA. Measuring of Lx on-time.	50	55	60	%
Maximum Oscillation Frequency1	MAX Fosc1	Same as I _{DD1} . 75% duty	85	100	115	kHz
Maximum Oscillation Frequency2	MAX Fosc2	Same as I _{DD1} . 55% duty	153	180	207	kHz
Stand-by Current	I _{STB}	Same as I _{DD1} .			0.5	μA
CE "High" Voltage	V _{CEH}	Same as I _{DD1} . Existence of Lx Oscillation.	0.75			V
CE "Low" Voltage	V _{CCL}	Same as I _{DD1} . Disappearance of Lx Oscillation.			0.20	V
CE "High" Current	I _{C EH}	Same as I _{DD1} . V _{C E} =V _{OUT} × 0.95.			0.25	μA
CE "Low" Current	I _{C CL}	Same as I _{DD1} . V _{C E} =0V.			-0.25	μA
Lx Limit Voltage	VLxLMT	Same as I _{DD1} . Fosc>MAXFosc1 × 2	0.7		1.1	V
Efficiency	EFFI	L, SD, C _L etc. connected		80		%

Measuring conditions: Unless otherwise specified, connect CE to V_{OUT}, V_{IN}=V_{OUT} × 0.6, I_{OUT}=30mA. See Typical Application Circuits, Fig.3.

Note: 1. The Schottky diode (SD) must be type MA735, with reverse current (I_R) < 1.0μA at reverse voltage (V_R)=10.0V

2. "Supply Current 1" is the supply current while the oscillator is continuously oscillating. In actual operation the oscillator periodically operates which results in less average power consumption. The current actually provided by an external V_{IN} source is represented by "No-Load Input Current (I_{IN})".

■ Electrical Characteristics

XC6383C501MR V_{OUT}=5.0V

T_a=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Voltage	V _{OUT}	L, SD, C _L etc. connected	4.875	5.000	5.125	V
Maximum Input Voltage	V _{IN}		10			V
Oscillation Start-up Voltage	V _{ST}	I _{OUT} =1mA		0.80	0.90	V
Oscillation Hold Voltage	V _{HLD}	I _{OUT} =1mA	0.70			V
No-Load Input Current	I _{IN}	I _{OUT} =0mA(Note1)		5.3	10.6	μA
Supply Current 1(Note2)	I _{DD1}	V _{IN} =V _{OUT} × 0.95		31.7	63.4	μA
Supply Current 2	I _{DD2}	V _{IN} =V _{OUT} +0.5V		2.4	4.8	μA
Lx Switch-On Resistance	R _{SWON}	Same as I _{DD1} . V _{LX} =0.4V.		2.8	4.3	Ω
Lx Leakage Current	I _{LxL}	No external components. V _{OUT} =V _{LX} =10V.			1.0	μA
Duty Ratio 1	DTY1	Same as I _{DD1} . Measuring of Lx waveform.	70	75	80	%
Duty Ratio 2	DTY2	I _{OUT} =1mA. Measuring of Lx on-time.	50	55	60	%
Maximum Oscillation Frequency1	MAX Fosc1	Same as I _{DD1} . 75% duty.	85	100	115	kHz
Maximum Oscillation Frequency2	MAX Fosc2	Same as I _{DD1} . 55% duty.	153	180	207	kHz
Stand-by Current	I _{STB}	Same as I _{DD1} .			0.5	μA
CE "High" Voltage	V _{CEH}	Same as I _{DD1} . Existence of Lx Oscillation.	0.75			V
CE "Low" Voltage	V _{CEL}	Same as I _{DD1} . Disappearance of Lx Oscillation.			0.20	V
CE "High" Current	I _{C EH}	Same as I _{DD1} . V _{C E} =V _{OUT} × 0.95.			0.25	μA
CE "Low" Current	I _{C EL}	Same as I _{DD1} . V _{C E} =0V.			-0.25	μA
Lx Limit Voltage	V _{LxLMT}	Same as I _{DD1} . Fosc>MAXFosc1 × 2	0.7		1.1	V
Efficiency	EFFI	L, SD, C _L etc. connected		85		%

Measuring conditions: Unless otherwise specified, connect CE to Vout, V_{IN}=V_{OUT} × 0.6, I_{OUT}=50mA. See Typical Application Circuits, Fig.3.

Note: 1. The Schottky diode (SD) must be type MA735, with reverse current (I_R) < 1.0μA at reverse voltage (V_R)=10.0V

2. "Supply Current 1" is the supply current while the oscillator is continuously oscillating. In actual operation the oscillator periodically operates which results in less average power consumption. The current actually provided by an external V_{IN} source is represented by "No-Load Input Current (I_{IN})".

■ Electrical Characteristics

XC6383D201MR V_{OUT}=2.0V

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Voltage	V _{OUT}	L, SD, C _L , Tr., etc. connected	1.950	2.000	2.050	V
Maximum Input Voltage	V _{IN}		10			V
Oscillation Start-up Voltage	V _{ST}	I _{OUT} =1mA		0.80	0.90	V
Oscillation Hold Voltage	V _{HLD}	I _{OUT} =1mA	0.70			V
Supply Current 1(Note1)	I _{DD1}	V _{IN} =V _{OUT} × 0.95		13.6	27.3	µA
Supply Current 2	I _{DD2}	V _{IN} =V _{OUT} +0.5V		1.9	3.9	µA
EXT "High" On Resistance	R _{EXTH}	Same as I _{DD1} . V _{EXT} =V _{OUT} -0.4V.		140	210	Ω
EXT "Low" On Resistance	R _{EXTL}	Same as I _{DD1} . V _{EXT} =4.0V.		140	210	Ω
Duty Ratio 1	DTY1	Same as I _{DD1} . Measuring of EXT waveform.	70	75	80	%
Duty Ratio 2	DTY2	I _{OUT} =1mA. Measuring of EXT on-time	50	55	60	%
Maximum Oscillation Frequency1	MAX Fosc1	Same as I _{DD1} . 75% duty.	85	100	115	kHz
Maximum Oscillation Frequency2	MAX Fosc2	Same as I _{DD1} . 55% duty.	153	180	207	kHz
Stand-by Current	I _{STB}	Same as I _{DD1} .			0.5	µA
CE "High" Voltage	V _{CEH}	Same as I _{DD1} . Existence of EXT Oscillation.	0.75			V
CE "Low" Voltage	V _{CEL}	Same as I _{DD1} . Disappearance of EXT Oscillation.			0.20	V
CE "High" Current	I _{C EH}	Same as I _{DD1} . V _{C E} =V _{OUT} × 0.95.			0.25	µA
CE "Low" Current	I _{C EL}	Same as I _{DD1} . V _{C E} =0V.			-0.25	µA
Efficiency	EFFI	L, SD, C _L , Tr., etc. connected		70		%

Measuring conditions: Unless otherwise specified, connect CE to V_{OUT}, V_{IN}=V_{OUT} × 0.6, I_{OUT}=10mA. See Typical Application Circuits, Fig.4.Note: 1."Supply Current 1" is the supply current while the oscillator is continuously oscillating. In actual operation the oscillator periodically operates which results in less average power consumption. The current actually provided by an external V_{IN} source is represented by "No-Load Input Current (I_{IN})".XC6383D301MR V_{OUT}=3.0V

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Voltage	V _{OUT}	L, SD, C _L , Tr., etc. connected	2.925	3.000	3.075	V
Maximum Input Voltage	V _{IN}		10			V
Oscillation Start-up Voltage	V _{ST}	I _{OUT} =1mA		0.80	0.90	V
Oscillation Hold Voltage	V _{HLD}	I _{OUT} =1mA	0.70			V
Supply Current 1(Note1)	I _{DD1}	V _{IN} =V _{OUT} × 0.95		19.7	39.4	µA
Supply Current 2	I _{DD2}	V _{IN} =V _{OUT} +0.5V		2.1	4.2	µA
EXT "High" On Resistance	R _{EXTH}	Same as I _{DD1} . V _{EXT} =V _{OUT} -0.4V.		76	114	Ω
EXT "Low" On Resistance	R _{EXTL}	Same as I _{DD1} . V _{EXT} =4.0V.		76	114	Ω
Duty Ratio 1	DTY1	Same as I _{DD1} . Measuring of EXT waveform.	70	75	80	%
Duty Ratio 2	DTY2	I _{OUT} =1mA. Measuring of EXT on-time	50	55	60	%
Maximum Oscillation Frequency1	MAX Fosc1	Same as I _{DD1} . 75% duty.	85	100	115	kHz
Maximum Oscillation Frequency2	MAX Fosc2	Same as I _{DD1} . 55% duty.	153	180	207	kHz
Stand-by Current	I _{STB}	Same as I _{DD1} .			0.5	µA
CE "High" Voltage	V _{C EH}	Same as I _{DD1} . Existence of EXT Oscillation.	0.75			V
CE "Low" Voltage	V _{C EL}	Same as I _{DD1} . Disappearance of EXT Oscillation.			0.20	V
CE "High" Current	I _{C EH}	Same as I _{DD1} . V _{C E} =V _{OUT} × 0.95.			0.25	µA
CE "Low" Current	I _{C EL}	Same as I _{DD1} . V _{C E} =0V.			-0.25	µA
Efficiency	EFFI	L, SD, C _L , Tr., etc. connected		80		%

Measuring conditions: Unless otherwise specified, connect CE to V_{OUT}, V_{IN}=V_{OUT} × 0.6, I_{OUT}=30mA. See Typical Application Circuits, Fig.4.Note: 1."Supply Current 1" is the supply current while the oscillator is continuously oscillating. In actual operation the oscillator periodically operates which results in less average power consumption. The current actually provided by an external V_{IN} source is represented by "No-Load Input Current (I_{IN})".

■ Electrical Characteristics

XC6383D501MR V_{OUT}=5.0V

T_a=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Voltage	V _{OUT}	L, SD, C _L , Tr., etc. connected	4.875	5.000	5.125	V
Maximum Input Voltage	V _{IN}		10			V
Oscillation Start-up Voltage	V _{ST}	I _{OUT} =1mA		0.80	0.90	V
Oscillation Hold Voltage	V _{HLD}	I _{OUT} =1mA	0.70			V
Supply Current 1(Note1)	I _{DD1}	V _{IN} =V _{OUT} × 0.95		31.7	63.4	μA
Supply Current 2	I _{DD2}	V _{IN} =V _{OUT} +0.5V		2.4	4.8	μA
EXT "High" On Resistance	R _{EXTH}	Same as I _{DD1} . V _{EXT} =V _{OUT} -0.4V.		50	75	Ω
EXT "Low" On Resistance	R _{EXTL}	Same as I _{DD1} . V _{EXT} =4.0V.		50	75	Ω
Duty Ratio 1	DTY1	Same as I _{DD1} . Measuring of EXT waveform.	70	75	80	%
Duty Ratio 2	DTY2	I _{OUT} =1mA. Measuring of EXT on-time	50	55	60	%
Maximum Oscillation Frequency1	MAX Fosc1	Same as I _{DD1} . 75% duty.	85	100	115	kHz
Maximum Oscillation Frequency2	MAX Fosc2	Same as I _{DD1} . 55% duty.	153	180	207	kHz
Stand-by Current	I _{STB}	Same as I _{DD1} .			0.5	μA
CE "High" Voltage	V _{CEH}	Same as I _{DD1} . Existence of EXT Oscillation.	0.75			V
CE "Low" Voltage	V _{CEL}	Same as I _{DD1} . Disappearance of EXT Oscillation.			0.20	V
CE "High" Current	I _{C EH}	Same as I _{DD1} . V _{C E} =V _{OUT} × 0.95.			0.25	μA
CE "Low" Current	I _{C EL}	Same as I _{DD1} . V _{C E} =0V.			-0.25	μA
Efficiency	EFFI	L, SD, C _L , Tr., etc. connected		85		%

Measuring conditions: Unless otherwise specified, connect CE to V_{OUT}, V_{IN}=V_{OUT} × 0.6, I_{OUT}=50mA. See Typical Application Circuits, Fig.4.

Note: 1."Supply Current 1" is the supply current while the oscillator is continuously oscillating. In actual operation the oscillator periodically operates which results in less average power consumption. The current actually provided by an external V_{IN} source is represented by "No-Load Input Current (I_{IN})".

XC6383E201MR V_{OUT}=2.0V

T_a=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Voltage	V _{OUT}	L, SD, C _L etc. connected	1.950	2.000	2.050	V
Maximum Input Voltage	V _{IN}		10			V
Oscillation Start-up Voltage	V _{ST}	I _{OUT} =1mA.		0.80	0.90	V
Oscillation Hold Voltage	V _{HLD}	I _{OUT} =1mA.	0.70			V
No-Load Input Current	I _{IN}	I _{OUT} =0mA(Note 1)		4.3	8.6	μA
Supply Current 1(Note2)	I _{DD1}	V _{IN} =V _{OUT} × 0.95		13.6	27.3	μA
Supply Current 2	I _{DD2}	V _{IN} =V _{OUT} +0.5V		1.9	3.9	μA
Lx Switch-On Resistance	R _{SWON}	Same as I _{DD1} . VLx=0.4V.		9.1	13.7	Ω
Lx Leakage Current	I _{LxL}	No external components. V _{OUT} =VLx=10V.			1.0	μA
Duty Ratio 1	DTY1	Same as I _{DD1} . Measuring of Lx waveform.	70	75	80	%
Duty Ratio 2	DTY2	I _{OUT} =1mA. Measuring of Lx on-time	50	55	60	%
Maximum Oscillation Frequency1	MAX Fosc1	Same as I _{DD1} . 75% duty.	85	100	115	kHz
Maximum Oscillation Frequency2	MAX Fosc2	Same as I _{DD1} . 55% duty.	153	180	207	kHz
Lx Limit Voltage	VLxLMT	Same as I _{DD1} . Fosc>MAXFosc × 2	0.7		1.1	V
Efficiency	EFFI	L, SD, C _L etc. connected		70		%

Measuring conditions: Unless otherwise specified, connect V_{DD} to V_{OUT}, V_{IN}=V_{OUT} × 0.6, I_{OUT}=10mA. See Typical Application Circuits, Fig.5.

Note: 1. The Schottky diode (SD) must be type MA735, with reverse current (I_R) < 1.0μA at reverse voltage (V_R)=10.0V.

2. "Supply Current 1" is the supply current while the oscillator is continuously oscillating. In actual operation the oscillator periodically operates which results in less average power consumption. The current actually provided by an external V_{IN} source is represented by "No-Load Input Current (I_{IN})".

*When the V_{DD} and V_{OUT} pins are independently used, the voltage range at the V_{DD} pin should be 2.2V to 10V. The IC operates from V_{DD}=0.8V. However, output voltage and oscillator frequency are properly stabilized when V_{DD}=2.2V or higher.

■ Electrical Characteristics

XC6383E301MR V_{OUT}=3.0V

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Voltage	V _{OUT}	L, SD, C _L etc. connected	2.925	3.000	3.075	V
Maximum Input Voltage	V _{IN}		10			V
Oscillation Start-up Voltage	V _{ST}	I _{OUT} =1mA.		0.80	0.90	V
Oscillation Hold Voltage	V _{HLD}	I _{OUT} =1mA.	0.70			V
No-Load Input Current	V _{IN}	I _{OUT} =0mA(Note 1)		4.6	9.3	μA
Supply Current 1(Note2)	I _{DD1}	V _{IN} =V _{OUT} × 0.95		19.7	39.4	μA
Supply Current 2	I _{DD2}	V _{IN} =V _{OUT} +0.5V		2.1	4.2	μA
Lx Switch-On Resistance	R _{SWON}	Same as I _{DD1} . VLx=0.4V.		5.2	7.9	Ω
Lx Leakage Current	I _{LxL}	No external components. V _{OUT} =VLx=10V.			1.0	μA
Duty Ratio 1	DTY1	Same as I _{DD1} Measuring of Lx waveform.	70	75	80	%
Duty Ratio 2	DTY2	I _{OUT} =1mA. Measuring of Lx on-time	50	55	60	%
Maximum Oscillation Frequency1	MAX Fosc1	Same as I _{DD1} . 75% duty.	85	100	115	kHz
Maximum Oscillation Frequency2	MAX Fosc2	Same as I _{DD1} . 55% duty.	153	180	207	kHz
Lx Limit Voltage	VLxLMT	Same as I _{DD1} . Fosc>MAXFosc × 2	0.7		1.1	V
Efficiency	EFFI	L, SD, C _L etc. connected		80		%

Measuring conditions: Unless otherwise specified, connect V_{DD} to V_{OUT}, V_{IN}=V_{OUT} × 0.6, I_{OUT}=30mA. See Typical Application Circuits, Fig.5.Note: 1. The Schottky diode (SD) must be type MA735, with reverse current (I_R) < 1.0μA at reverse voltage (V_R)=10.0V.2. "Supply Current 1" is the supply current while the oscillator is continuously oscillating. In actual operation the oscillator periodically operates which results in less average power consumption. The current actually provided by an external V_{IN} source is represented by "No-Load Input Current (I_{IN})".※When the V_{DD} and V_{OUT} pins are independently used, the voltage range at the V_{DD} pin should be 2.2V to 10V. The IC operates from V_{DD}=0.8V. However, output voltage and oscillator frequency are properly stabilized when V_{DD}=2.2V or higher.XC6383E501MR V_{OUT}=5.0V

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Voltage	V _{OUT}	L, SD, C _L etc. connected	4.875	5.000	5.125	V
Maximum Input Voltage	V _{IN}		10			V
Oscillation Start-up Voltage	V _{ST}	I _{OUT} =1mA.		0.80	0.90	V
Oscillation Hold Voltage	V _{HLD}	I _{OUT} =1mA.	0.70			V
No-Load Input Current	I _{IN}	I _{OUT} =0mA(Note 1)		5.3	10.6	μA
Supply Current 1(Note2)	I _{DD1}	V _{IN} =V _{OUT} × 0.95		31.7	63.4	μA
Supply Current 2	I _{DD2}	V _{IN} =V _{OUT} +0.5V		2.4	4.8	μA
Lx Switch-On Resistance	R _{SWON}	Same as I _{DD1} . VLx=0.4V.		2.8	4.3	Ω
Lx Leakage Current	I _{LxL}	No external components. V _{OUT} =VLx=10V.			1.0	μA
Duty Ratio 1	DTY1	Same as I _{DD1} Measuring of Lx waveform.	70	75	80	%
Duty Ratio 2	DTY2	I _{OUT} =1mA. Measuring of Lx on-time	50	55	60	%
Maximum Oscillation Frequency1	MAX Fosc1	Same as I _{DD1} . 75% duty.	85	100	115	kHz
Maximum Oscillation Frequency2	MAX Fosc2	Same as I _{DD1} . 55% duty.	153		207	kHz
Lx Limit Voltage	VLxLMT	Same as I _{DD1} . Fosc>MAXFosc × 2	0.7		1.1	V
Efficiency	EFFI	L, SD, C _L etc. connected		85		%

Measuring conditions: Unless otherwise specified, connect V_{DD} to V_{OUT}, V_{IN}=V_{OUT} × 0.6, I_{OUT}=50mA. See Typical Application Circuits, Fig.5.Note: 1. The Schottky diode (SD) must be type MA735, with reverse current (I_R) < 1.0μA at reverse voltage (V_R)=10.0V.2. "Supply Current 1" is the supply current while the oscillator is continuously oscillating. In actual operation the oscillator periodically operates which results in less average power consumption. The current actually provided by an external V_{IN} source is represented by "No-Load Input Current (I_{IN})".※When the V_{DD} and V_{OUT} pins are independently used, the voltage range at the V_{DD} pin should be 2.2V to 10V. The IC operates from V_{DD}=0.8V. However, output voltage and oscillator frequency are properly stabilized when V_{DD}=2.2V or higher.

■ Electrical Characteristics

XC6383F201MR V_{OUT}=2.0V

T_a=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Voltage	V _{OUT}	L, SD, C _L , Tr., etc. connected	1.950	2.000	2.050	V
Maximum Input Voltage	V _{IN}		10			V
Oscillation Start-up Voltage	V _{ST}	I _{OUT} =1mA		0.80	0.90	V
Oscillation Hold Voltage	V _{HLD}	I _{OUT} =1mA	0.70			V
Supply Current 1(Note1)	I _{DD1}	V _{IN} =V _{OUT} × 0.95		13.6	27.3	μA
Supply Current 2	I _{DD2}	V _{IN} =V _{OUT} +0.5V		1.9	3.9	μA
EXT "High" On Resistance	R _{EXTH}	Same as I _{DD1} . V _{EXT} =V _{OUT} -0.4V.		140	210	Ω
EXT "Low" On Resistance	R _{EXTL}	Same as I _{DD1} . V _{EXT} =0.4V.		140	210	Ω
Duty Ratio 1	DTY1	Same as I _{DD1} Measuring of EXT waveform.	70	75	80	%
Duty Ratio 2	DTY2	I _{OUT} =1mA. Measuring of EXT on-time.	50	55	60	%
Maximum Oscillation Frequency1	MAX Fosc1	Same as I _{DD1} . 75% duty.	85	100	115	kHz
Maximum Oscillation Frequency2	MAX Fosc2	Same as I _{DD1} . 55% duty.	153	180	207	kHz
Efficiency	EFFI	L, SD, C _L , Tr., etc. connected		70		%

Measuring conditions: Unless otherwise specified, connect V_{DD} to V_{OUT}, V_{IN}=V_{OUT} × 0.6, I_{OUT}=10mA. See Typical Application Circuits, Fig.6.

Note: 1. "Supply Current 1" is the supply current while the oscillator is continuously oscillating. In actual operation the oscillator periodically operates which results in less average power consumption.

※When the V_{DD} and V_{OUT} pins are independently used, the voltage range at the V_{DD} pin should be 2.2V to 10V. The IC operates from V_{DD}=0.8V. However, output voltage and oscillator frequency are properly stabilized when V_{DD}=2.2V or higher.

XC6383F301MR V_{OUT}=3.0V

T_a=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Voltage	V _{OUT}	L, SD, C _L , Tr., etc. connected	2.925	3.000	3.075	V
Maximum Input Voltage	V _{IN}		10			V
Oscillation Start-up Voltage	V _{ST}	I _{OUT} =1mA		0.80	0.90	V
Oscillation Hold Voltage	V _{HLD}	I _{OUT} =1mA	0.70			V
Supply Current 1(Note1)	I _{DD1}	V _{IN} =V _{OUT} × 0.95		19.7	39.4	μA
Supply Current 2	I _{DD2}	V _{IN} =V _{OUT} +0.5V		2.1	4.2	μA
EXT "High" On Resistance	R _{EXTH}	Same as I _{DD1} . V _{EXT} =V _{OUT} -0.4V.		76	114	Ω
EXT "Low" On Resistance	R _{EXTL}	Same as I _{DD1} . V _{EXT} =0.4V.		76	114	Ω
Duty Ratio 1	DTY1	Same as I _{DD1} Measuring of EXT waveform.	70	75	80	%
Duty Ratio 2	DTY2	I _{OUT} =1mA. Measuring of EXT on-time.	50	55	60	%
Maximum Oscillation Frequency1	MAX Fosc1	Same as I _{DD1} . 75% duty.	85	100	115	kHz
Maximum Oscillation Frequency2	MAX Fosc2	Same as I _{DD1} . 55% duty.	153	180	207	kHz
Efficiency	EFFI	L, SD, C _L , Tr., etc. connected		80		%

Measuring conditions: Unless otherwise specified, connect V_{DD} to V_{OUT}, V_{IN}=V_{OUT} × 0.6, I_{OUT}=30mA. See Typical Application Circuits, Fig.6.

Note: 1. "Supply Current 1" is the supply current while the oscillator is continuously oscillating. In actual operation the oscillator periodically operates which results in less average power consumption.

※When the V_{DD} and V_{OUT} pins are independently used, the voltage range at the V_{DD} pin should be 2.2V to 10V. The IC operates from V_{DD}=0.8V. However, output voltage and oscillator frequency are properly stabilized when V_{DD}=2.2V or higher.

■ Electrical Characteristics

XC6383F501MR V_{OUT}=5.0V

Ta=25°C

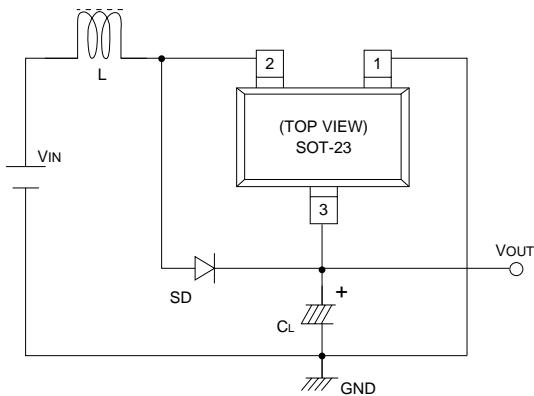
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Output Voltage	V _{OUT}	L, SD, C _L , Tr., etc. connected	4.875	5.000	5.125	V
Maximum Input Voltage	V _{IN}		10			V
Oscillation Start-up Voltage	V _{ST}	I _{OUT} =1mA		0.80	0.90	V
Oscillation Hold Voltage	V _{HLD}	I _{OUT} =1mA	0.70			V
Supply Current 1(Note1)	I _{DD1}	V _{IN} =V _{OUT} × 0.95		31.7	63.4	μA
Supply Current 2	I _{DD2}	V _{IN} =V _{OUT} +0.5V		2.4	4.9	μA
EXT "High" On Resistance	R _{EXTH}	Same as I _{DD1} . V _{EXT} =V _{OUT} -0.4V.		50	75	Ω
EXT "Low" On Resistance	R _{EXTL}	Same as I _{DD1} . V _{EXT} =0.4V.		50	75	Ω
Duty Ratio 1	DTY1	Same as I _{DD1} Measuring of EXT waveform.	70	75	80	%
Duty Ratio 2	DTY2	I _{OUT} =1mA. Measuring of EXT on-time.	50	55	60	%
Maximum Oscillation Frequency1	MAX Fosc1	Same as I _{DD1} . 75% duty.	85	100	115	kHz
Maximum Oscillation Frequency2	MAX Fosc2	Same as I _{DD1} . 55% duty.	153	180	207	kHz
Efficiency	EFFI	L, SD, C _L , Tr., etc. connected		85		%

Measuring conditions: Unless otherwise specified, connect V_{DD} to V_{OUT}, V_{IN}=V_{OUT} × 0.6, I_{OUT}=50mA. See Typical Application Circuits, Fig.6.

Note: 1. "Supply Current 1" is the supply current while the oscillator is continuously oscillating. In actual operation the oscillator periodically operates which results in less average power consumption.

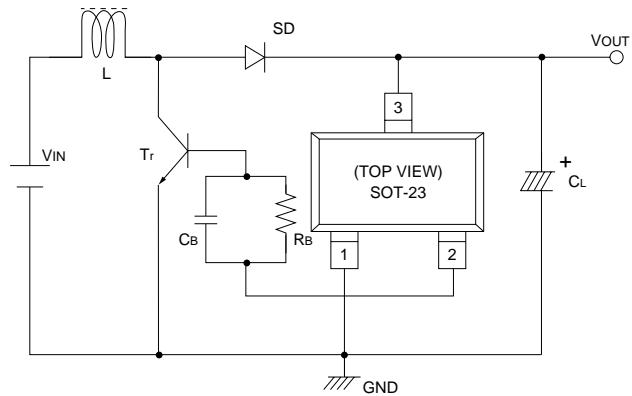
※When the V_{DD} and V_{OUT} pins are independently used, the voltage range at the V_{DD} pin should be 2.2V to 10V. The IC operates from V_{DD}=0.8V. However, output voltage and oscillator frequency are properly stabilized when V_{DD}=2.2V or higher.

■ Typical Application Circuits



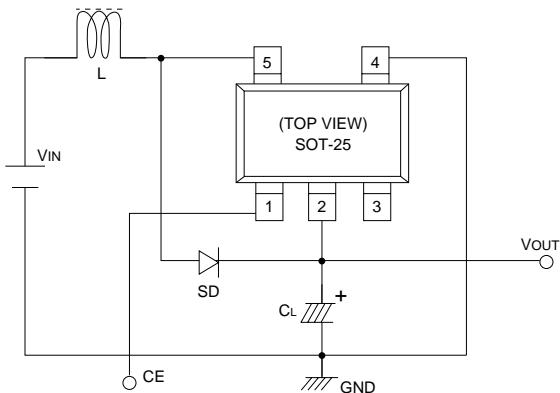
L: 100 μ H (SUMIDA, CD-54)
SD: MA735 (Schottky diode; MATSUSHITA)
CL: 16V 47 μ F (Tantalum capacitor, NICHICON, F93)

Fig.1 XC6383A Application



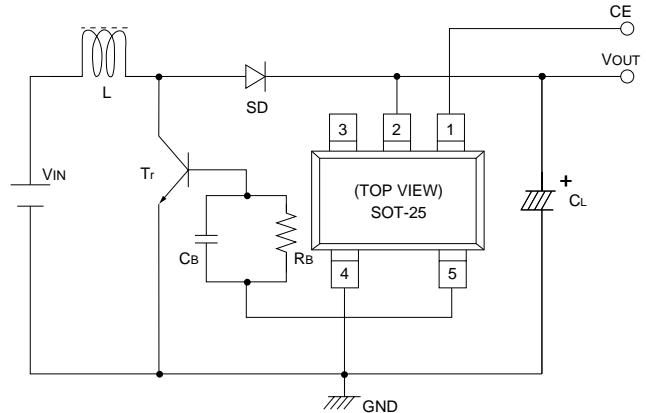
L: 47 μ H (SUMIDA, CD-54)
SD: MA735 (Schottky diode; MATSUSHITA)
CL: 16V 47 μ F (Tantalum capacitor, NICHICON, F93)
RB: 1k Ω , CB: 3300pF
Tr: 2SC3279, 2SD1628G

Fig.2 XC6383B Application



L: 100 μ H (SUMIDA, CD-54)
SD: MA735 (Schottky diode; MATSUSHITA)
CL: 16V 47 μ F (Tantalum capacitor, NICHICON, F93)

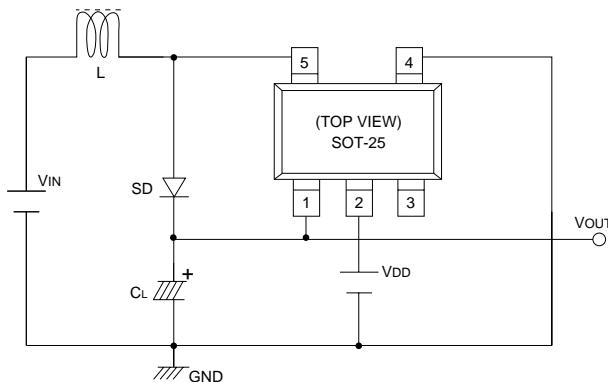
Fig.3 XC6383C Application



L: 47 μ H (SUMIDA, CD-54)
SD: MA735 (Schottky diode; MATSUSHITA)
CL: 16V 47 μ F (Tantalum capacitor, NICHICON, F93)
RB: 1k Ω , CB: 3300pF
Tr: 2SC3279, 2SD1628G

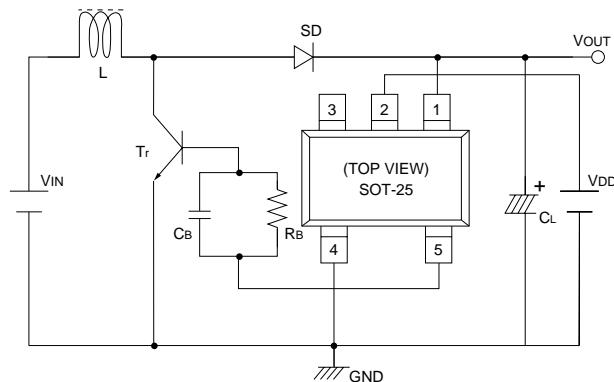
Fig.4 XC6383D Application

■ Typical Application Circuits



L: 100 μ H (SUMIDA, CD-54)
SD: MA735 (Schottky diode; MATSUSHITA)
CL: 16V 47 μ F (Tantalum capacitor, NICHICON, F93)

Fig.5 XC6383E Application



L: 47 μ H (SUMIDA, CD-54)
SD: MA735 (Schottky diode; MATSUSHITA)
CL: 16V 47 μ F (Tantalum capacitor, NICHICON, F93)
Rb: 1k Ω , Cb: 3300pF
Tr: 2SC3279, 2SD1628G

Fig.6 XC6383F Application

(Step-Down circuit.....built-in switching transistor type)

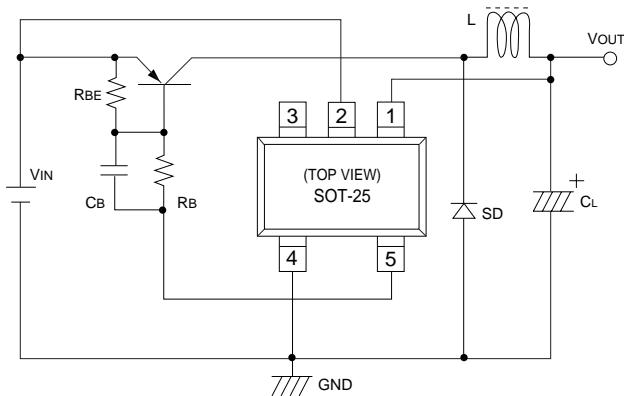


Fig.7 XC6383E Application

(High Output Voltage circuit.....external switching transistor type)

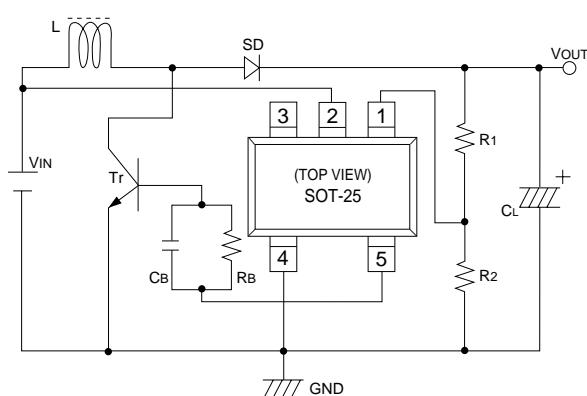


Fig.8 XC6383F Application

■ Typical Application Circuits

(Polarity Reverse circuit.....built-in switching transistor type)

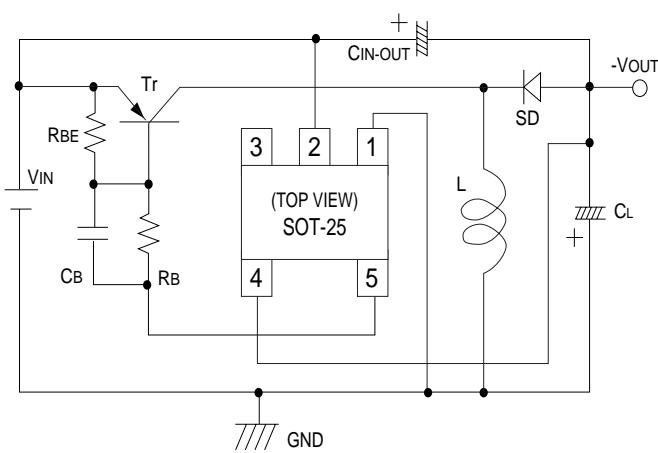


Fig.9 XC6383E Application

Note: It is recommended that the max.
input voltage between the V_{DD} and V_{ss} pins should
not exceed 10V.

(Low Output Voltage step-up circuit.....

external switching transistor type)

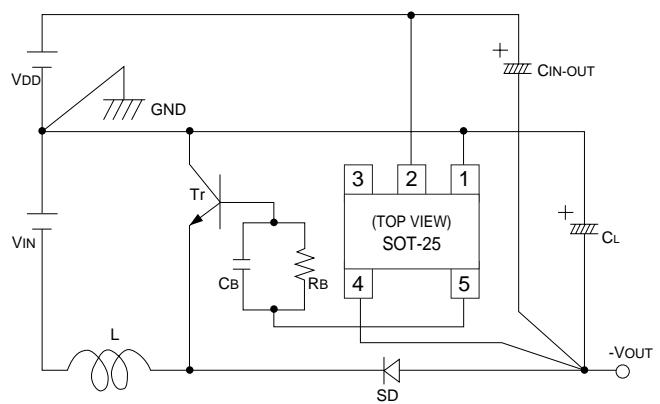


Fig.10 XC6383F Application

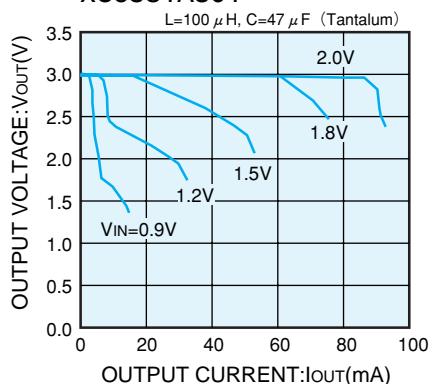
Note: It is recommended that the max.
input voltage between the V_{DD} and V_{ss} pins should
not exceed 10V.

*Also applicable to the XC6381 and XC6382 series.

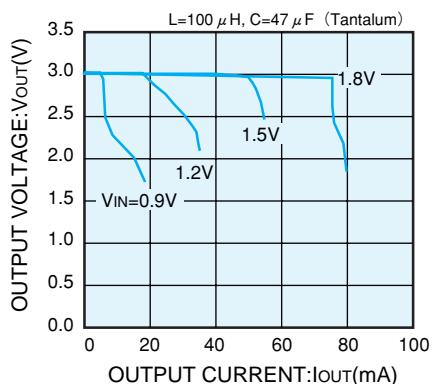
■ XC638xA (Built-in Switching Transistor)

(1) OUTPUT VOLTAGE vs. OUTPUT CURRENT

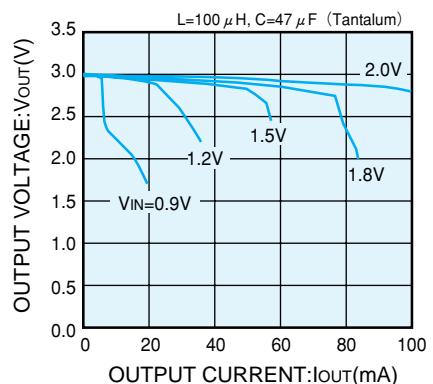
XC6381A301



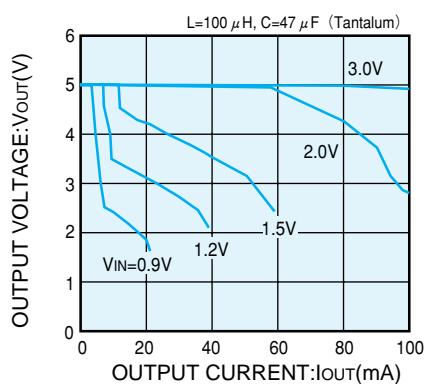
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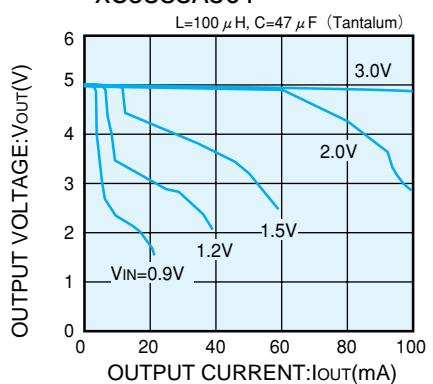
XC6383A301



XC6382A501

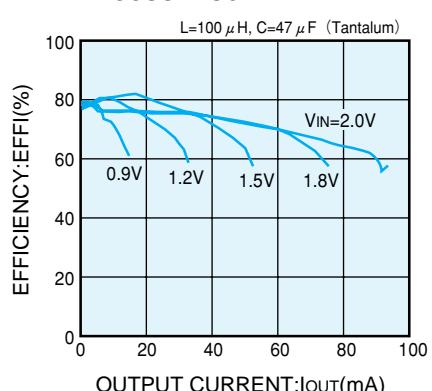


XC6383A501

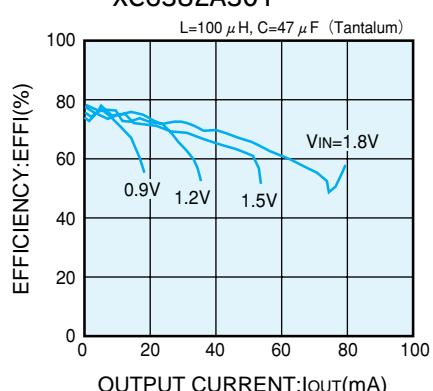


(2) EFFICIENCY vs. OUTPUT CURRENT

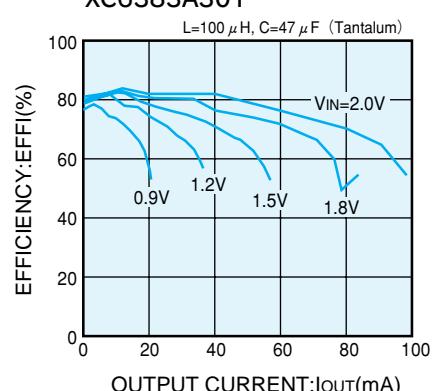
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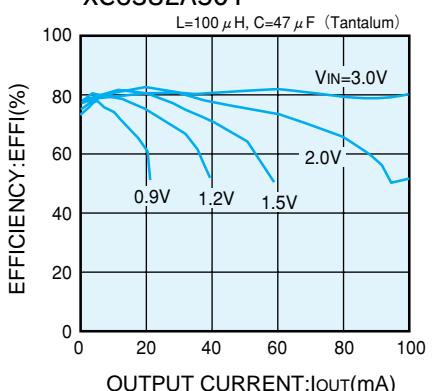
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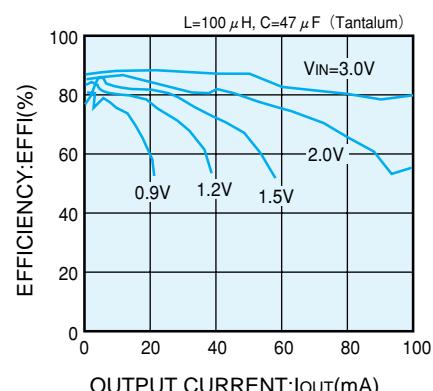
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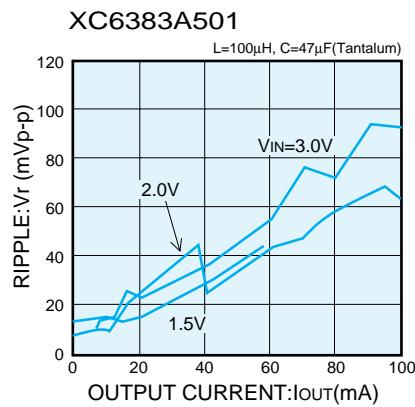
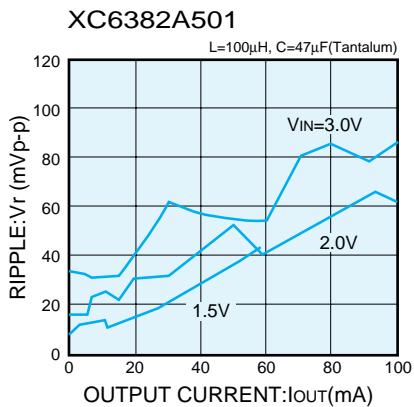
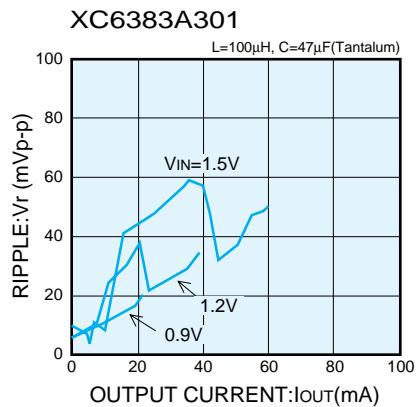
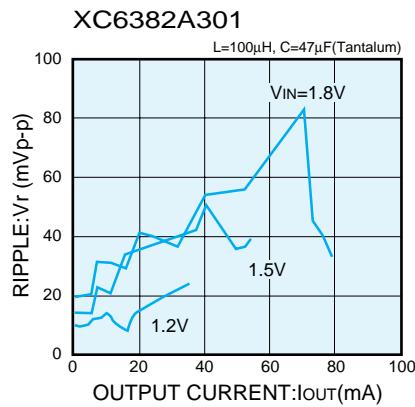
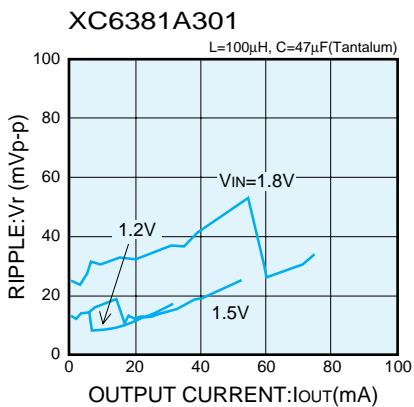


XC6383A501



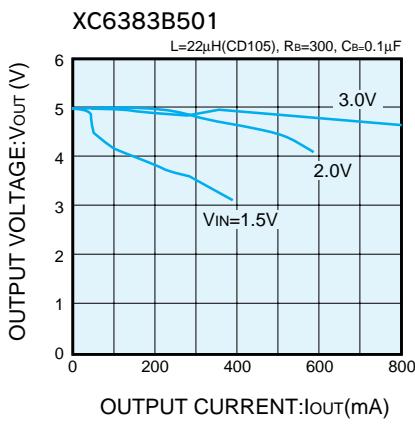
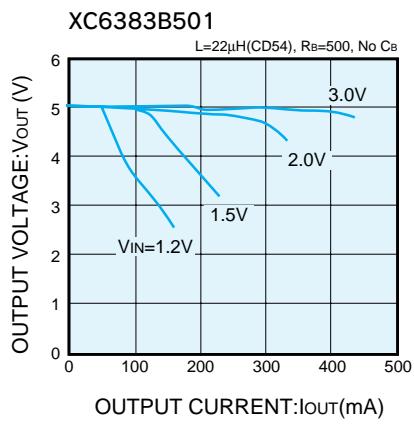
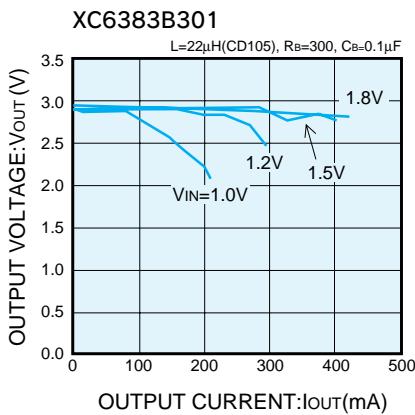
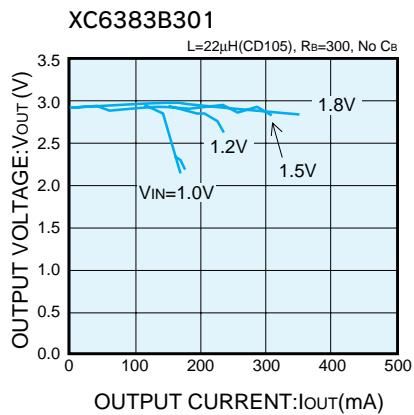
■ XC638xA (Built-in Switching Transistor)

(3) RIPPLE VOLTAGE vs. OUTPUT CURRENT



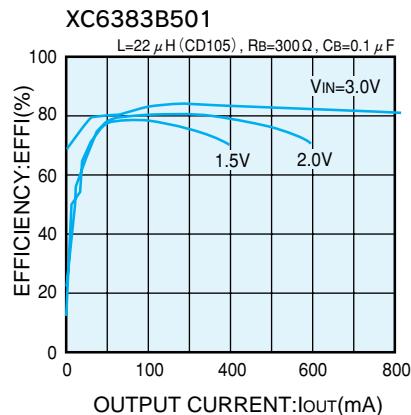
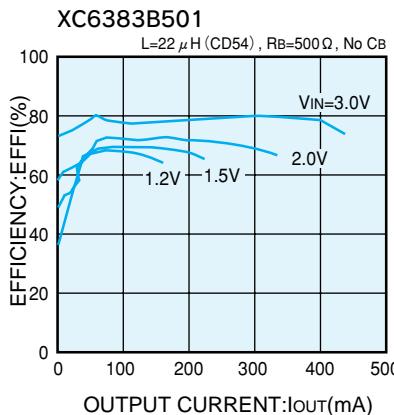
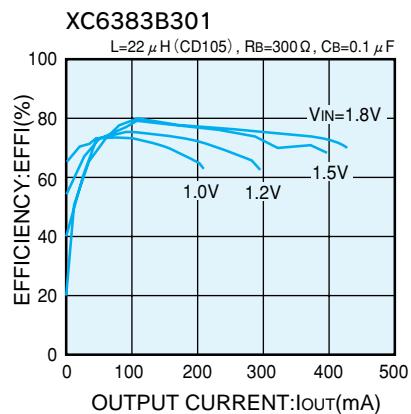
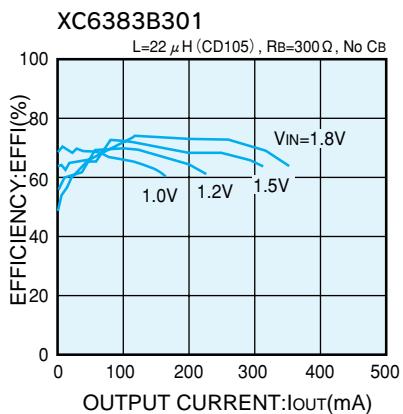
■ XC638xB (External Switching Transistor)

(1) TYPICAL OUTPUT VOLTAGE vs. OUTPUT CURRENT

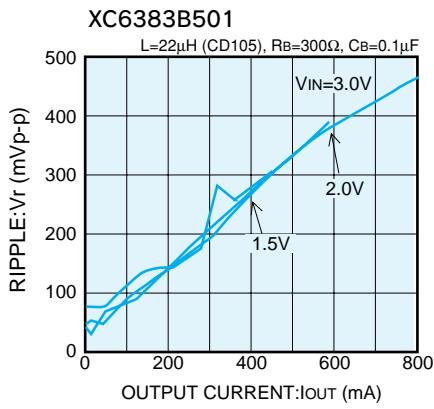
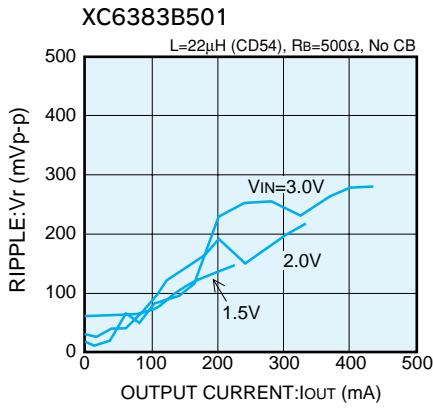
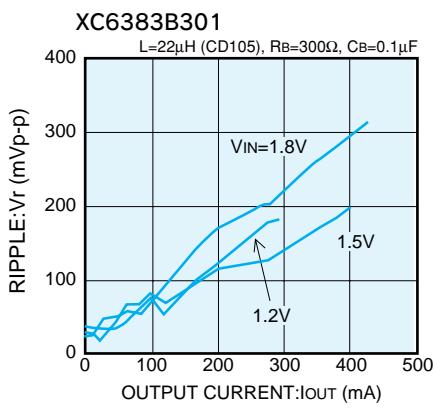
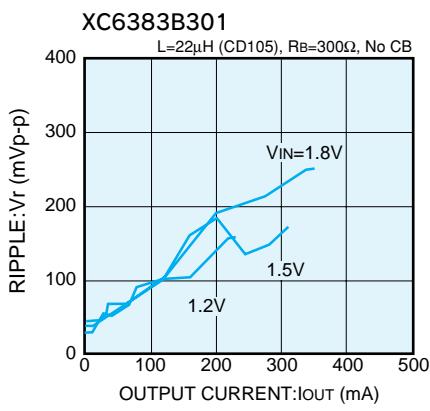


■ XC638xB (External Switching Transistor)

(2) EFFICIENCY vs. OUTPUT CURRENT

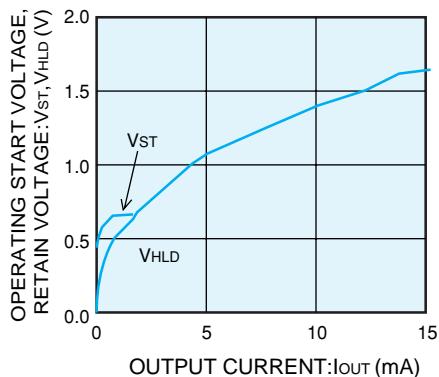


(3) RIPPLE VOLTAGE vs. OUTPUT CURRENT

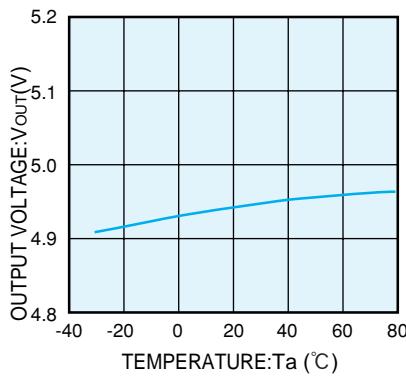


■ XC6383A501 Characteristics

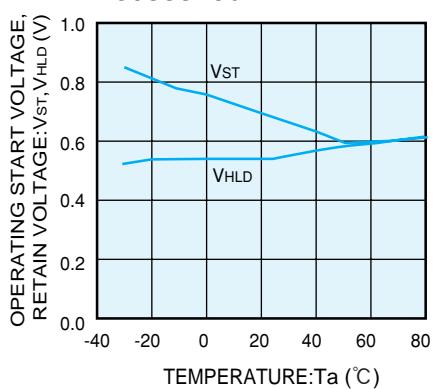
(1) OPERATING START VOLTAGE, RETAIN VOLTAGE vs. OUTPUT CURRENT
XC6383A501



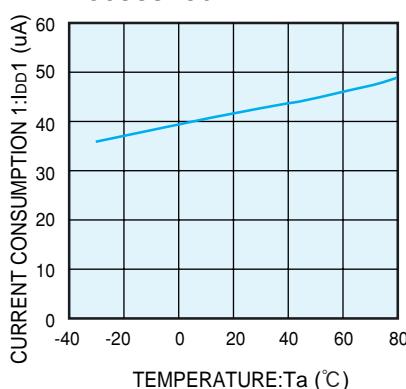
(2) OUTPUT VOLTAGE vs. TEMPERATURE
XC6383A501



(3) OPERATING START VOLTAGE, RETAIN VOLTAGE vs. TEMPERATURE
XC6383A501

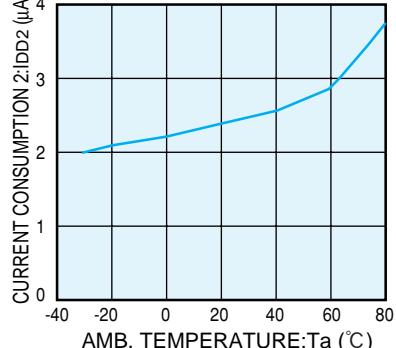


(4) CURRENT CONSUMPTION 1 vs. TEMPERATURE
XC6383A501

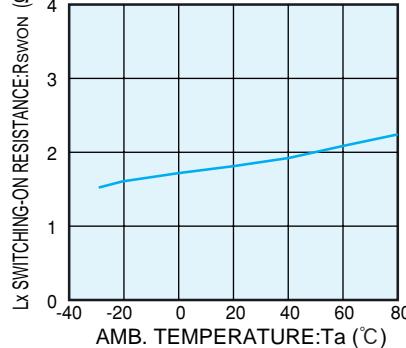


■ XC6383A501 Characteristics

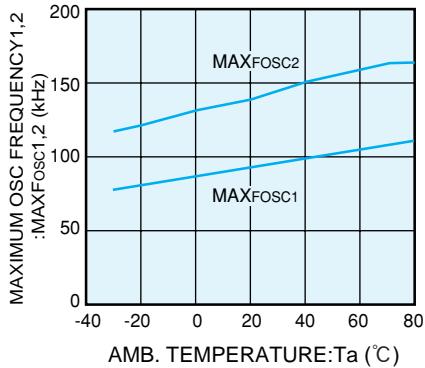
(5) CURRENT CONSUMPTION 2 vs. TEMPERATURE
XC6383A501



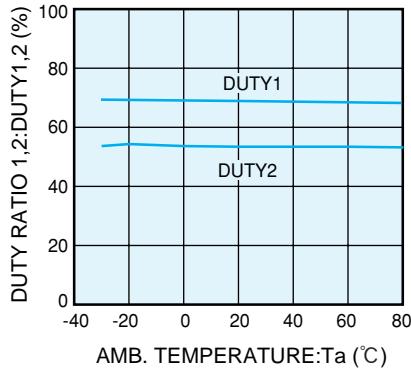
(6) Lx SWITCHING-ON RESISTANCE vs. TEMPERATURE
XC6383A501



(7) MAX. OSC FREQUENCY1,2 vs. AMB. TEMPERATURE
XC6383A501

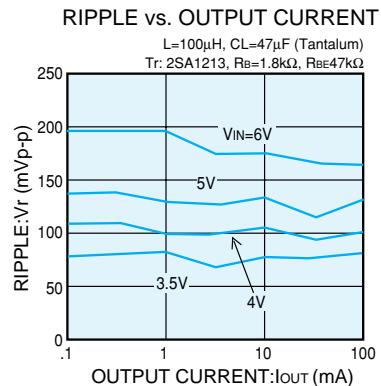
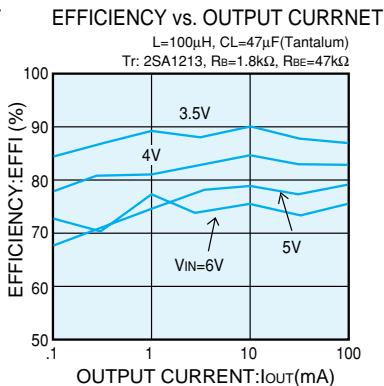
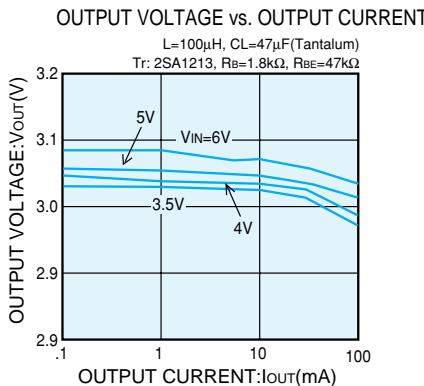


(8) DUTY RATIO 1,2 vs. AMB. TEMPERATURE
XC6383A501



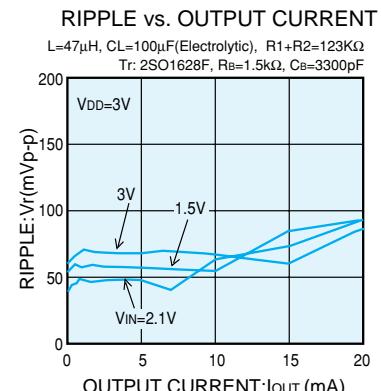
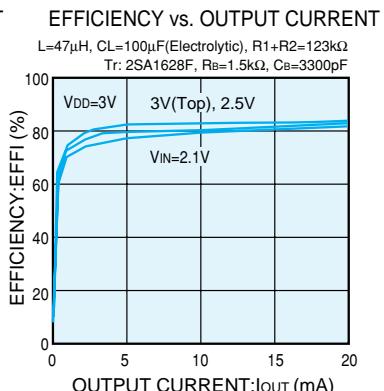
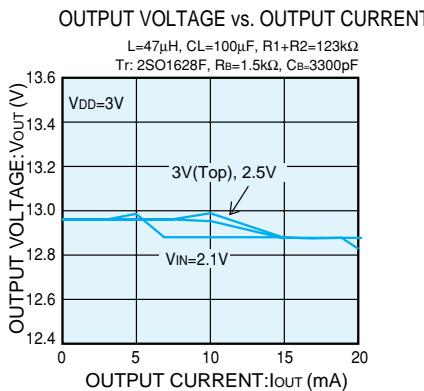
■ HIGH VOLTAGE OUTPUT CIRCUIT MEASUREMENT (XC6383F APPLICATIONS)

XC6383E301



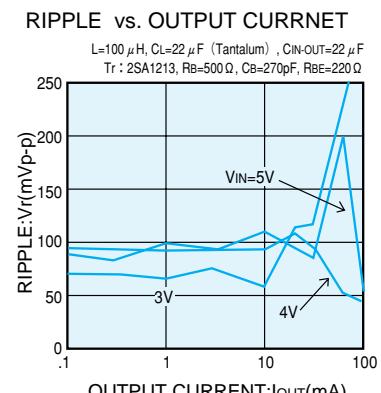
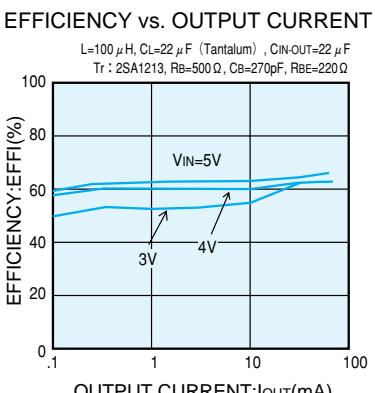
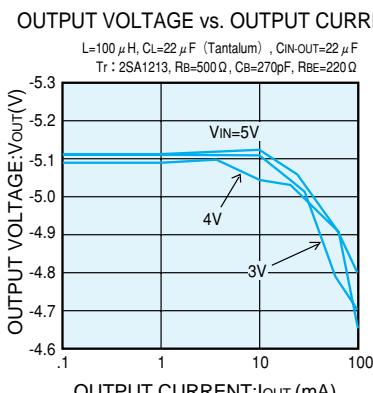
■ HIGH VOLTAGE OUTPUT CIRCUIT MEASUREMENT (XC6383F APPLICATIONS)

XC6383F501



■ POLARITY REVERSE CIRCUIT MEASUREMENT (XC6383E APPLICATIONS)

XC6383E501



■ NEGATIVE VOLTAGE STEP-UP CIRCUIT CHARACTERISTICS (XC6383F APPLICATIONS)

XC6383F501

